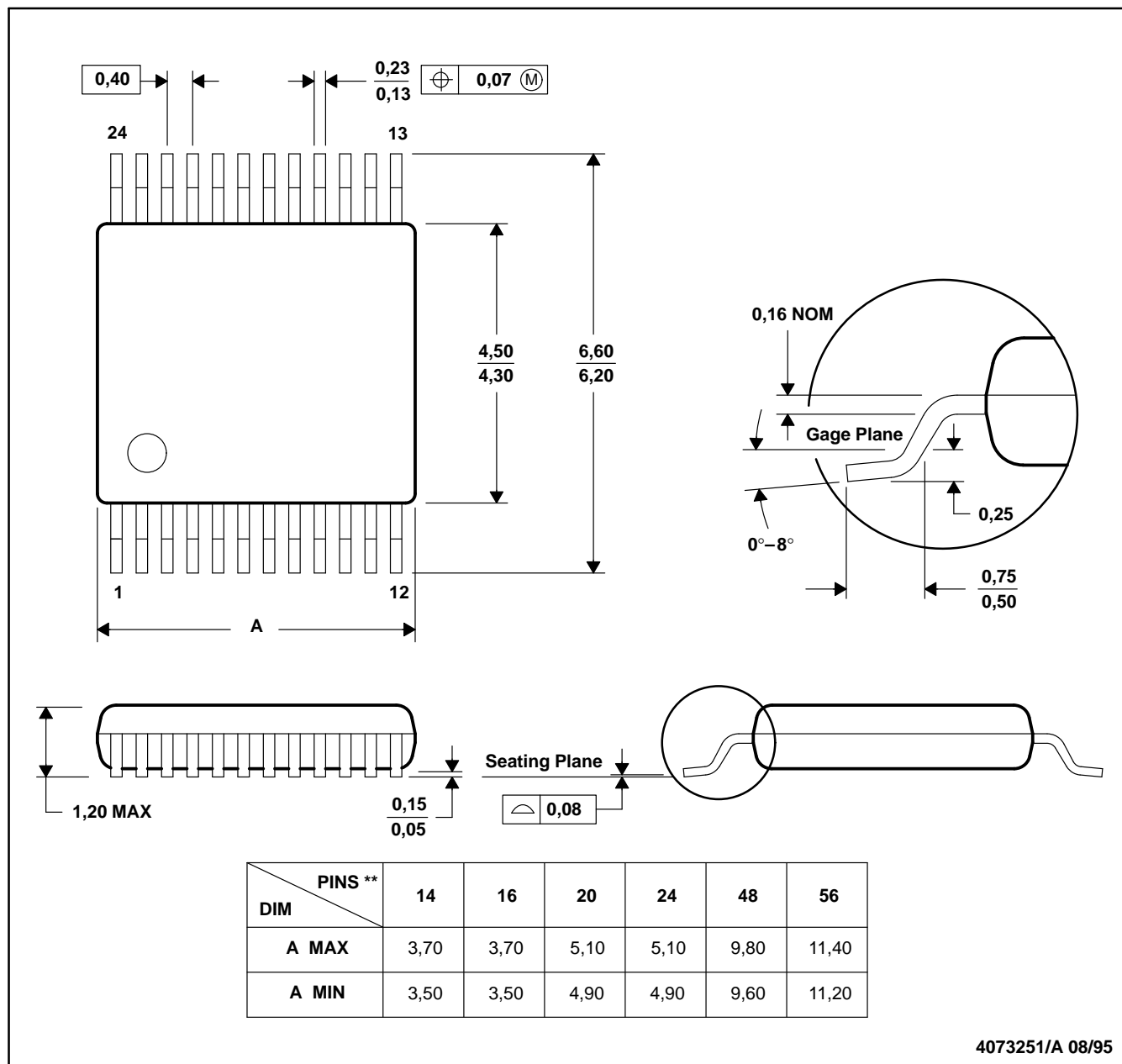


DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

24 PIN SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

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